

DYNAMIC CHARACTERISTICS

APT5015BVFR_SVFR

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C_{iss}	Input Capacitance	$V_{GS} = 0V$ $V_{DS} = 25V$ $f = 1 \text{ MHz}$		4400	5280	pF
C_{oss}	Output Capacitance			600	840	
C_{rss}	Reverse Transfer Capacitance			230	350	
Q_g	Total Gate Charge ③	$V_{GS} = 10V$ $V_{DD} = 0.5 V_{DSS}$ $I_D = I_D [\text{Cont.}] @ 25^\circ\text{C}$		200	300	nC
Q_{gs}	Gate-Source Charge			30	45	
Q_{gd}	Gate-Drain ("Miller") Charge			80	120	
$t_{d(on)}$	Turn-on Delay Time	$V_{GS} = 15V$ $V_{DD} = 0.5 V_{DSS}$ $I_D = I_D [\text{Cont.}] @ 25^\circ\text{C}$ $R_G = 1.6\Omega$		12	25	ns
t_r	Rise Time			14	30	
$t_{d(off)}$	Turn-off Delay Time			55	80	
t_f	Fall Time			11	20	

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
I_S	Continuous Source Current (Body Diode)			32	Amps
I_{SM}	Pulsed Source Current ① (Body Diode)			128	
V_{SD}	Diode Forward Voltage ② ($V_{GS} = 0V$, $I_S = -I_D [\text{Cont.}]$)			1.3	Volts
dv/dt	Peak Diode Recovery dv/dt ⑤			15	V/ns
t_{rr}	Reverse Recovery Time ($I_S = -I_D [\text{Cont.}]$, $di/dt = 100A/\mu s$)	$T_j = 25^\circ\text{C}$		250	ns
		$T_j = 125^\circ\text{C}$		525	
Q_{rr}	Reverse Recovery Charge ($I_S = -I_D [\text{Cont.}]$, $di/dt = 100A/\mu s$)	$T_j = 25^\circ\text{C}$	1.6		μC
		$T_j = 125^\circ\text{C}$	6.0		
I_{RRM}	Peak Recovery Current ($I_S = -I_D [\text{Cont.}]$, $di/dt = 100A/\mu s$)	$T_j = 25^\circ\text{C}$	13		Amps
		$T_j = 125^\circ\text{C}$	21		

THERMAL CHARACTERISTICS

Symbol	Characteristic	MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to Case			0.34	$^\circ\text{C/W}$
$R_{\theta JA}$	Junction to Ambient			40	

① Repetitive Rating: Pulse width limited by maximum junction temperature.

② Pulse Test: Pulse width < 380 μs , Duty Cycle < 2%

③ See MIL-STD-750 Method 3471

④ Starting $T_j = +25^\circ\text{C}$, $L = 2.54\text{mH}$, $R_G = 25\Omega$, Peak $I_L = 32\text{A}$

⑤ $I_S = -I_D [\text{Cont.}]$, $di/dt = 100A/\mu s$, $V_{DD} = V_{DSS}$, $T_j = 150^\circ\text{C}$, $R_G = 2.0\Omega$, $V_R = 200V$.

APT Reserves the right to change, without notice, the specifications and information contained herein.

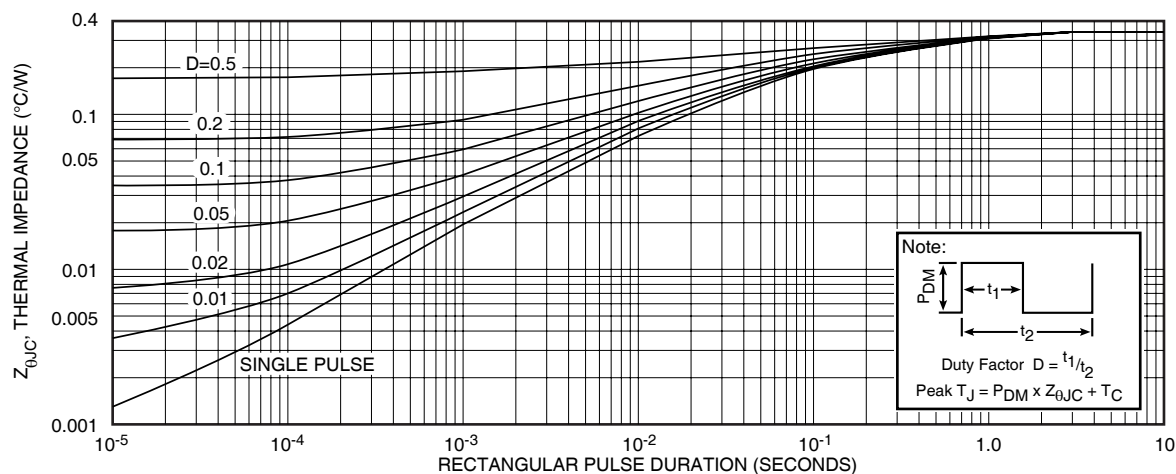


FIGURE 1, MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs PULSE DURATION

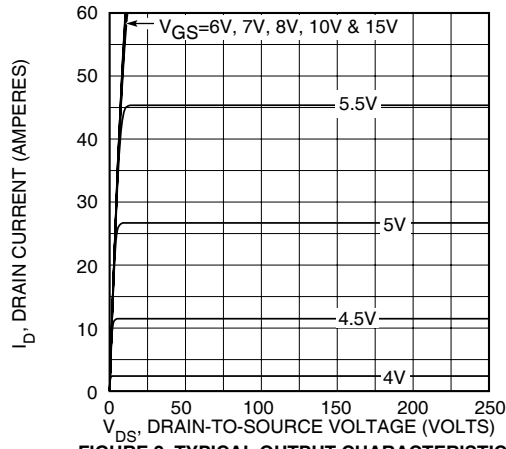


FIGURE 2, TYPICAL OUTPUT CHARACTERISTICS

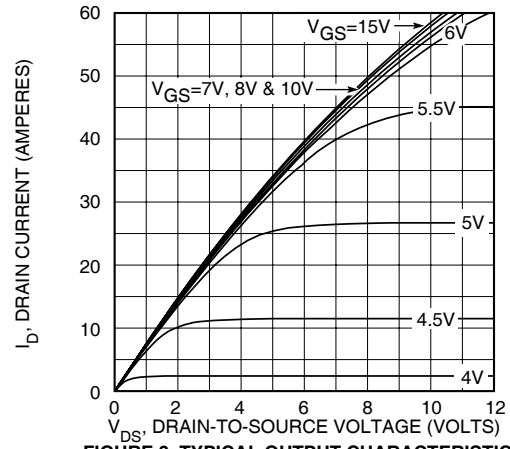


FIGURE 3, TYPICAL OUTPUT CHARACTERISTICS

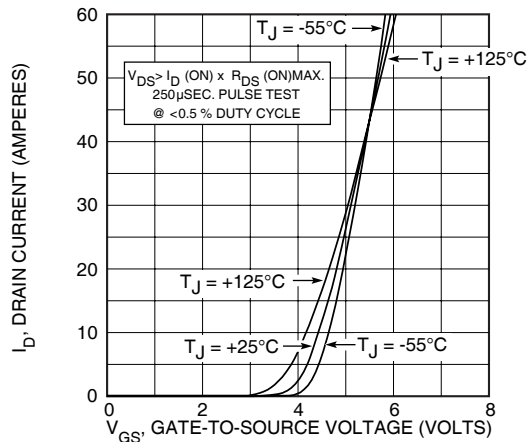


FIGURE 4, TYPICAL TRANSFER CHARACTERISTICS

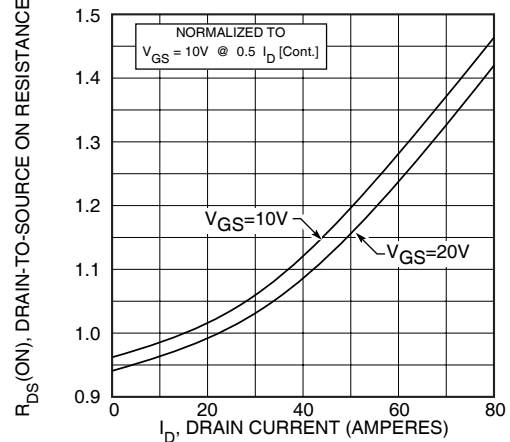


FIGURE 5, $R_{DS(ON)}$ vs DRAIN CURRENT

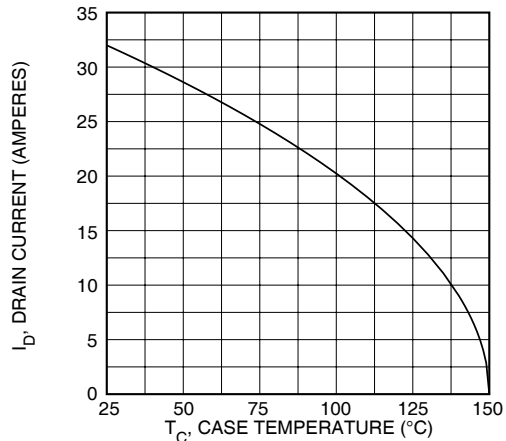


FIGURE 6, MAXIMUM DRAIN CURRENT vs CASE TEMPERATURE

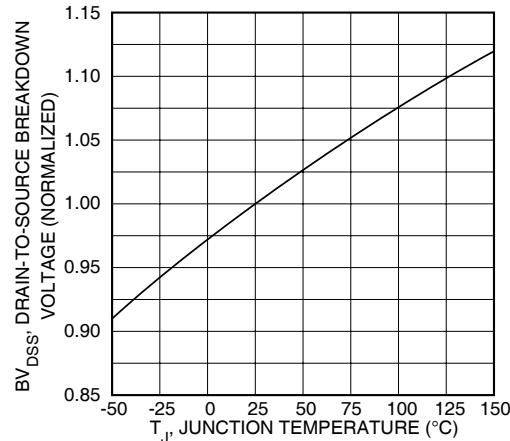


FIGURE 7, BREAKDOWN VOLTAGE vs TEMPERATURE

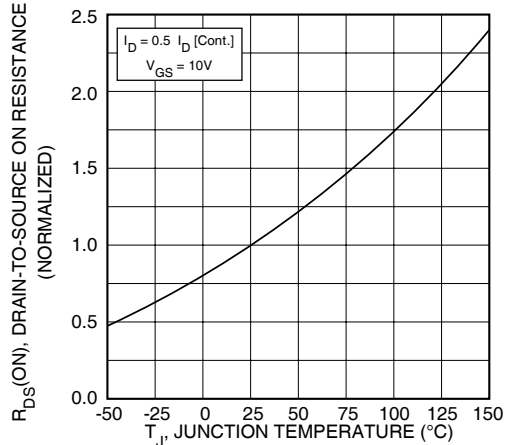


FIGURE 8, ON-RESISTANCE vs. TEMPERATURE

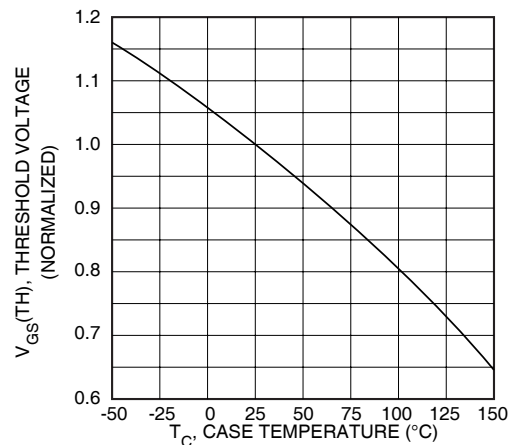


FIGURE 9, THRESHOLD VOLTAGE vs TEMPERATURE

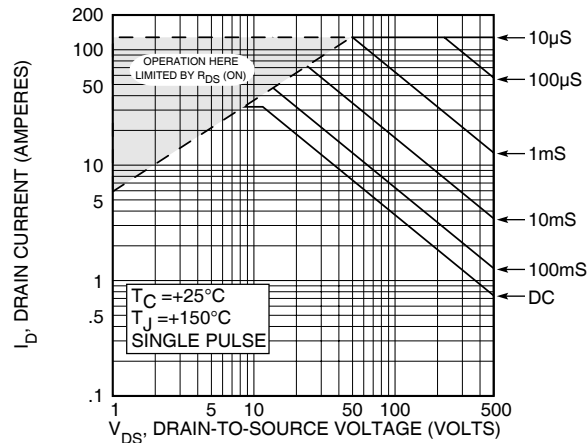


FIGURE 10, MAXIMUM SAFE OPERATING AREA

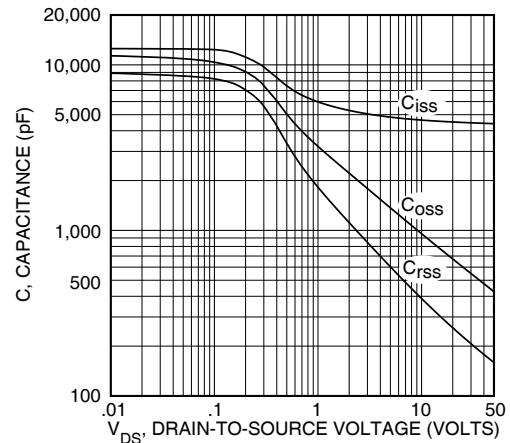


FIGURE 11, TYPICAL CAPACITANCE vs DRAIN-TO-SOURCE VOLTAGE

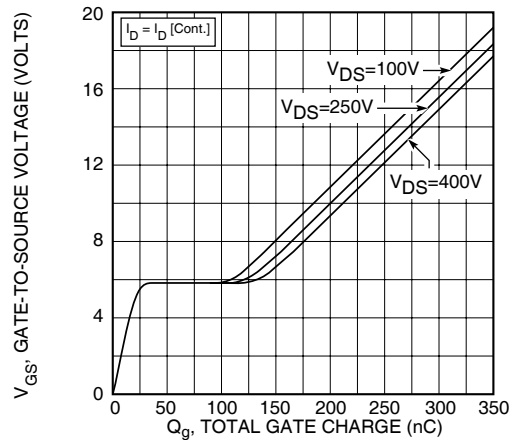


FIGURE 12, GATE CHARGES vs GATE-TO-SOURCE VOLTAGE

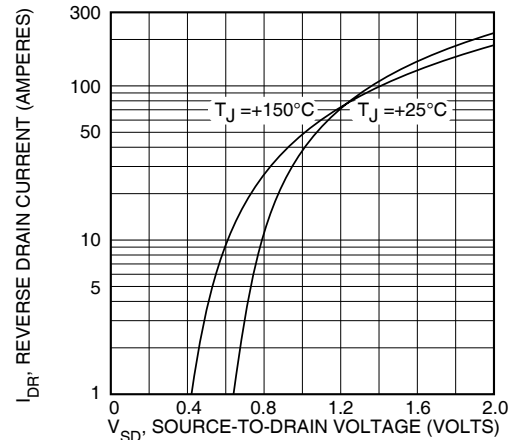
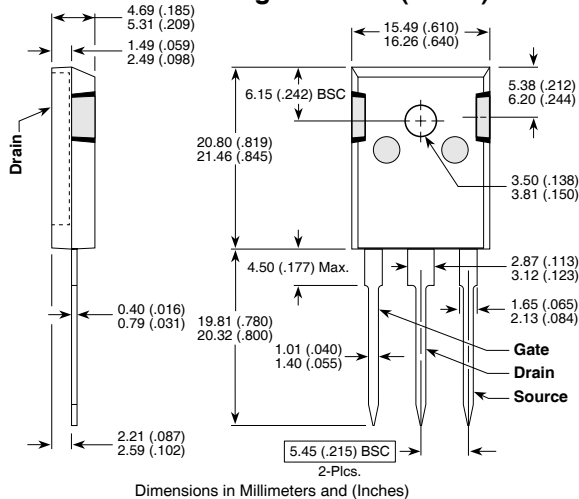
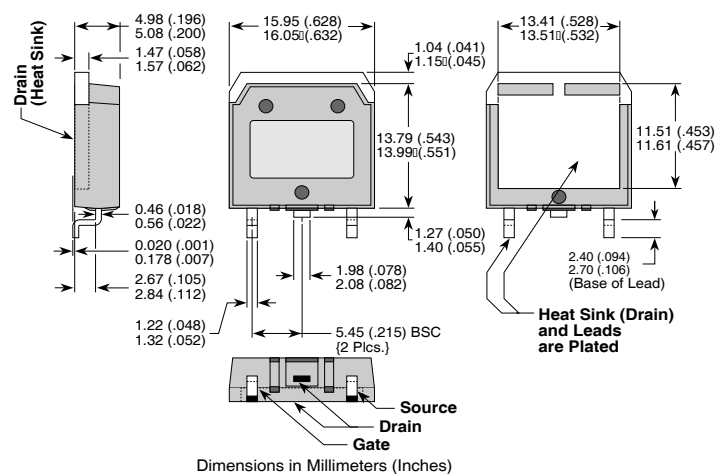


FIGURE 13, TYPICAL SOURCE-DRAIN DIODE FORWARD VOLTAGE

TO-247 Package Outline (BVFR)



Dimensions in Millimeters and (Inches)

D³PAK Package Outline (SVFR)

Dimensions in Millimeters (Inches)

APT's products are covered by one or more of U.S. patents 4,895,810 5,045,903 5,089,434 5,182,234 5,019,522

5,262,336 6,503,786 5,256,583 4,748,103 5,283,202 5,231,474 5,434,095 5,528,058 and foreign patents. US and Foreign patents pending. All Rights Reserved.